

## Freescale Semiconductor Application Note

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# PCB Layout Guidelines for MPC5674x Switch Mode Power Supply (SMPS)

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### 1 Overview

Switched regulators have become popular for their improved efficiency and frequency response compared to equivalent linear regulators. A system based on switched supplies can provide significantly lower power consumption, and consequently allow reduced printed circuit board area and a reduction in cost of external components.

The MPC5674F device provides an internal SMPS regulator that may be used to provide the  $V_{DD}$  voltage, eliminating the external  $V_{DD}$  supply. To ensure that the switched regulator operates as designed, it is important that the designer select appropriate components and design the PCB following some simple rules. A good PCB layout is of particular importance when using the switchmode regulator.

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**Layout Guidelines** 

## 2 Layout Guidelines

These simple component and layout guidelines ensure an effective layout:

- The input power supply capacitor C1, output capacitor C2, and inductor shown in Figure 1 should be located very close to the power MOS-Schottky diode.
- The common power ground for nodes with high switching currents should be separated from nodes with low switching currents.
- Minimize the inductance between the switching supply node and the decoupling/filtering capacitor, so that decoupling is effective and minimum energy is radiated.
- Star-connect all grounds to the ground plane below the MOS-Schottky device.
- Keep gate control signal VRCTRL far from switching signals.
- Keep smaller EMI capacitors underneath the microcontroller.
- Use the 5 V power track exclusively as power to the drain of the power MOS by means of star connection to the global 5 V power supply.

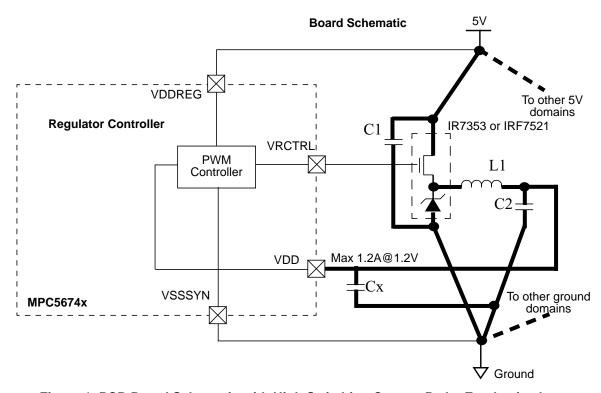


Figure 1. PCB Board Schematic with High Switching Current Paths Emphasized

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# 3 External Components

- N-MOS + Schottky diode. Current rating >1.6 A over temperature, low Vt (max 1.5 V), low Vf (max 0.5 V) and low Qg (max 12 nC @ 4.5 V).
- 2.2 μH nominal coil with current rating of 1.6 A or more across temperature range (Coilcraft DO3316T-222MLB, TDK RLF7030T-2R2M5R4, or equivalent).
- $6 \times 2.2 \ \mu F$  capacitors with ESR  $< 20 \ m\Omega$  across temperature range. Should be able to withstand high voltages (>20 V) and fast transients (TDK RLF7030T-2R2M5R4, AVX-08053C225KAT2A, or equivalent).

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# 4 PCB Layout Example

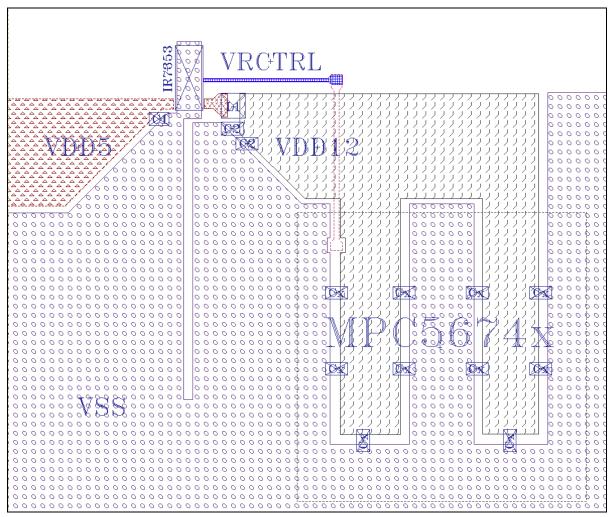


Figure 2. PCB Layout, Common Practice Example

#### **NOTE**

This example is not in scale and does not represent actual pinout of the device. It is provided to describe figuratively the concept explained in the guideline rules.



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